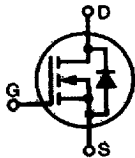


HiPerFET™  
Power MOSFET

IXFH24N50S

Surface Mountable  
N-Channel Enhancement-Mode  
Avalanche Rated, High dv/dt, Low  $t_{rr}$

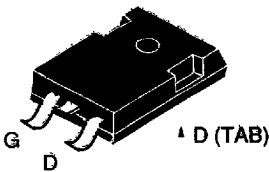
Preliminary data



$V_{DSS} = 500\text{ V}$   
 $I_{D25} = 24\text{ A}$   
 $R_{DS(on)} = 0.23\ \Omega$   
 $t_{rr} \leq 250\text{ ns}$

| Symbol    | Test Conditions                                                                                                                         | Maximum Ratings |                  |
|-----------|-----------------------------------------------------------------------------------------------------------------------------------------|-----------------|------------------|
| $V_{DSS}$ | $T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$                                                                                         | 500             | V                |
| $V_{DGR}$ | $T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$ ; $R_{GS} = 10\text{ k}\Omega$                                                          | 500             | V                |
| $V_{GS}$  | Continuous                                                                                                                              | $\pm 20$        | V                |
| $V_{GSM}$ | Transient                                                                                                                               | $\pm 30$        | V                |
| $I_{D25}$ | $T_C = 25^\circ\text{C}$ ,                                                                                                              | 24              | A                |
| $I_{DM}$  | $T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$                                                                              | 96              | A                |
| $I_{AR}$  | $T_C = 25^\circ\text{C}$                                                                                                                | 24              | A                |
| $E_{AR}$  | $T_C = 25^\circ\text{C}$                                                                                                                | 30              | mJ               |
| dv/dt     | $I_S \leq I_{DM}$ , $di/dt \leq 100\text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ ,<br>$T_J \leq 150^\circ\text{C}$ , $R_G = 2\ \Omega$ | 5               | V/ns             |
| $P_D$     | $T_C = 25^\circ\text{C}$                                                                                                                | 300             | W                |
| $T_J$     |                                                                                                                                         | -55 ... +150    | $^\circ\text{C}$ |
| $T_{JM}$  |                                                                                                                                         | 150             | $^\circ\text{C}$ |
| $T_{sig}$ |                                                                                                                                         | -55 ... +150    | $^\circ\text{C}$ |
| $T_L$     | for lead and tab, 10 s for soldering                                                                                                    | 300             | $^\circ\text{C}$ |
| Weight    |                                                                                                                                         | 4               | g                |

TO-247 SMD



G = Gate, D = Drain,  
S = Source, TAB = Drain

Features

- Surface mount package
- Low  $R_{DS(on)}$  HDMOS™ process
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance (<5 nH)  
- easy to drive and to protect
- Fast intrinsic Rectifier

Applications

- AC Motor Control
- DC-DC converters
- Synchronous rectification
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls
- Low voltage relays

Advantages

- Suitable for surface mounting
- Space savings
- High power density

| Symbol       | Test Conditions                                                                                                       | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |                            |
|--------------|-----------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|------|----------------------------|
|              |                                                                                                                       | min.                                                                              | typ. | max.                       |
| $V_{DSS}$    | $V_{GS} = 0\text{ V}$ , $I_D = 250\ \mu\text{A}$                                                                      | 500                                                                               |      | V                          |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 4\text{ mA}$                                                                               | 2                                                                                 |      | 4.5 V                      |
| $I_{GSS}$    | $V_{GS} = \pm 20\text{ V}_{DC}$ , $V_{DS} = 0$                                                                        |                                                                                   |      | $\pm 100\text{ nA}$        |
| $I_{DSS}$    | $V_{DS} = 0.8 \cdot V_{DSS}$<br>$V_{GS} = 0\text{ V}$                                                                 |                                                                                   |      | $200\ \mu\text{A}$<br>1 mA |
| $R_{DS(on)}$ | $V_{GS} = 10\text{ V}$ , $I_D = 0.5 \cdot I_{D25}$<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$ |                                                                                   |      | 0.23 $\Omega$              |

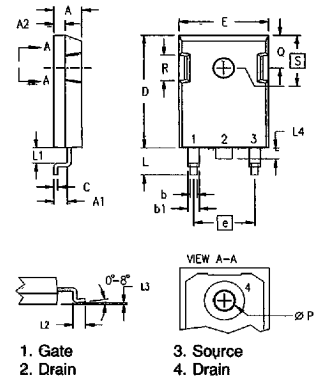
IXYS reserves the right to change limits, test conditions and dimensions.

| Symbol       | Test Conditions                                                                                       | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |        |
|--------------|-------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|------|--------|
|              |                                                                                                       | min.                                                                              | typ. | max.   |
| $g_{fs}$     | $V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$ , pulse test                                          | 15                                                                                | 21   | S      |
| $C_{iss}$    | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$                                         |                                                                                   | 4200 | pF     |
| $C_{oss}$    |                                                                                                       |                                                                                   | 420  | pF     |
| $C_{rss}$    |                                                                                                       |                                                                                   | 135  | pF     |
| $t_{d(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 50\text{ V}, I_D = 0.5 \cdot I_{D25}$<br>$R_G = 2\ \Omega$ (External) |                                                                                   | 16   | 25 ns  |
| $t_r$        |                                                                                                       |                                                                                   | 33   | 45 ns  |
| $t_{d(off)}$ |                                                                                                       |                                                                                   | 65   | 80 ns  |
| $t_f$        |                                                                                                       |                                                                                   | 30   | 40 ns  |
| $Q_{g(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$                           |                                                                                   | 135  | 120 nC |
| $Q_{gs}$     |                                                                                                       |                                                                                   | 28   | 40 nC  |
| $Q_{gd}$     |                                                                                                       |                                                                                   | 62   | 85 nC  |
| $R_{thJC}$   |                                                                                                       |                                                                                   | 0.42 | K/W    |
| $R_{thCK}$   |                                                                                                       |                                                                                   | 0.25 | K/W    |

## Source-Drain Diode

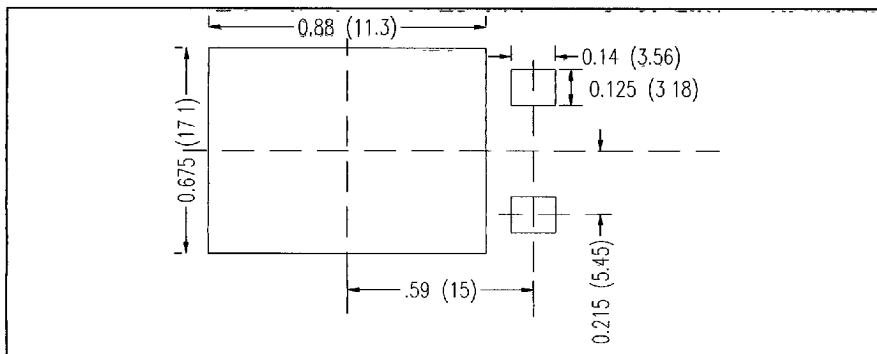
| Symbol   | Test Conditions                                                                                                                   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |                  |
|----------|-----------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|------|------------------|
|          |                                                                                                                                   | min.                                                                              | typ. | max.             |
| $I_S$    | $V_{GS} = 0$                                                                                                                      |                                                                                   |      | 24 A             |
| $I_{SM}$ | Repetitive; pulse width limited by $T_{JM}$                                                                                       |                                                                                   |      | 96 A             |
| $V_{SD}$ | $I_F = I_S, V_{GS} = 0\text{ V}$ ,<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $\delta \leq 2\%$                        |                                                                                   |      | 1.5 V            |
| $t_{rr}$ | $I_F = 25\text{ A}, -di/dt = 100\text{ A}/\mu\text{s}$ $T_J = 25^\circ\text{C}$<br>$V_R = 100\text{ V}$ $T_J = 125^\circ\text{C}$ |                                                                                   |      | 250 ns<br>400 ns |

## TO-247 SMD Outline



| Dim. | Millimeter |       | Inches |      |
|------|------------|-------|--------|------|
|      | Min.       | Max.  | Min.   | Max. |
| A    | 4.83       | 5.21  | .190   | .205 |
| A1   | 2.29       | 2.54  | .090   | .100 |
| A2   | 1.91       | 2.16  | .075   | .085 |
| b    | 1.14       | 1.40  | .045   | .055 |
| b1   | 1.91       | 2.13  | .075   | .084 |
| C    | 0.61       | 0.80  | .024   | .031 |
| D    | 20.80      | 21.34 | .819   | .840 |
| E    | 15.75      | 16.13 | .620   | .635 |
| e    | 5.45       | BSC   | .215   | BSC  |
| L    | 4.90       | 5.10  | .193   | .201 |
| L1   | 2.70       | 2.90  | .106   | .114 |
| L2   | 2.10       | 2.30  | .083   | .091 |
| L3   | 0.00       | 0.10  | .00    | .004 |
| L4   | 1.90       | 2.10  | .075   | .083 |
| ØP   | 3.55       | 3.65  | .140   | .144 |
| Q    | 5.59       | 6.20  | .220   | .244 |
| R    | 4.32       | 4.83  | .170   | .190 |
| S    | 6.15       | BSC   | .242   | BSC  |

## Min. Recommended Footprint (Dimensions in inches and mm)



IXFH 24N50S characteristic curves are located in the IXFH 24N50 data sheet, Publication No. D94010DE, pages 26 - 29.